

Depletion-Mode Power MOSFET

General Features

- Depletion Mode (Normally On)
- Proprietary Advanced Planar Technology
- Rugged Polysilicon Gate Cell Structure
- RoHS Compliant
- Halogen-free Available

Applications

- ➢ Transient Protect
- ➤ Start-up
- Converters
- > Normally On Switches
- LED Drive Circuits
- Power Supplies
- Current Source
- Voltage Source

Ordering Information

Part Number	Package	Marking	Remark
DMD4523E	TO-252	4523E	Halogen Free

Absolute Maximum Ratings

BV _{DSX}	RDS(ON)(Max.)	I _D
450V	2Ω	3.75A





Symbol	Parameter	DMD4523E	Unit
V _{DSX}	Drain-to-Source Voltage ^[1]	450	V
V _{DGX}	Drain-to-Gate Voltage ^[1]	450	V
ID	Continuous Drain Current	3.75	
I _{DM}	Pulsed Drain Current ^[2]	15	А
P _D	Power Dissipation	36	W
V _{GS}	Gate-to-Source Voltage	±20	V
V	Gate Source ESD ^[3]	3000	V
V ESD	Source to Gate ESD ^[3]	3000	V
T_L	Soldering Temperature Distance of 1.6mm from case for 10 seconds	300	°C
$T_{\rm J}$ and $T_{\rm STG}$	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	DMD4523E	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	3.47	°C/W



Electrical Characteristics OFF Characteristics

OFF Characteristics $T_A = 25^{\circ}C$ unless otherwise s						25℃ unless otherwise specified
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
$\mathrm{BV}_{\mathrm{DSX}}$	Drain-to-Source Breakdown Voltage	450			V	V_{GS} =-10V, I_D =250 μ A
I _{DS(OFF)}	Drain-to-Source Leakage Current			1	μA	V _{DS} =450V, V _{GS} =-10V
I _{GSS}	Gate-to-Source Leakage Current			20	- μΑ	V_{GS} =+20V, V_{DS} =0V
				-20		V_{GS} =-20V, V_{DS} =0V

ON Characteristics

 $T_A = 25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
R _{DS(ON)}	Static Drain-to-Source On-Resistance		-	2	Ω	$V_{GS}=0V, I_D=1A^{[4]}$
$V_{GS(OFF)}$	Gate-to-Source Cut-off Voltage	-1.7		-4.0	V	$V_{DS}=3V, I_D=8\mu A$
gfs	Forward Transconductance		3100		mS	$V_{DS}=5V, I_D=1A^{[4]}$

Dynamic Characteristics

Symbol **Parameter** Min. Max. Typ. Unit **Test Conditions** Input Capacitance C_{ISS} 1.11 nF --___ V_{GS}=-7V **Output Capacitance** 62.80 V_{DS}=25V Coss ---pF f=1.0MHZ **Reverse Transfer Capacitance** 6.54 CRSS --__ Total Gate Charge Q_{G} 158.82 ----- $V_{GS}=-6V\sim 0V$ Gate-to-Source Charge V_{DD}=25V Q_{GS} 58.26 ___ nC --ID=200mA Gate-to-Drain (Miller) Charge 50.55 Q_{GD} ___ ___

Resistive Switching Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
t _{d(on)}	Turn-on Delay Time		5.71		ns	$V_{GS} = -6V \sim 0V$ $V_{DD} = 25V$ $I_{D} = 200mA$
t _{rise}	Rise Time		18.45			
t _{d(off)}	Turn-off Delay Time		26.40			
t _{fall}	Fall Time		18.46			$R_{G}=10 \Omega$

Source-Drain Diode Characteristics $T_A=25^{\circ}C$ unless otherwise spec						25°C unless otherwise specified
Symbol	Parameter	Min	Тур.	Max.	Units	Test Conditions
V _{SD}	Diode Forward Voltage		0.8	1.5	V	$I_{SD}=200 \text{mA}^{[4]}, V_{GS}=-10 \text{V}$

NOTE:

[1] T_J=+25 °C to +150 °C

[2] Repetitive rating, pulse width limited by maximum junction temperature.

[3]The test is based on JEDEC EIA/JESD22-A114(HBM).

[4] Pulse width \leq 380µs; duty cycle \leq 2%.

Essentially independent of operating temperature

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Typical Characteristics

Figure 1. Maximum Power Dissipation vs. Case Temperature























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Typical Application

In circuits of capacitive loads, instruments, and communication equipment, using DMD4523E can effectively suppress transient surges and provide overcurrent protection. As shown in Figure 7, In the circuit, only one depletion mode MOSFET and a resistor are used to limit the magnitude of the current flowing through the load and provide overcurrent protection. The application of DMD4523E has the characteristics of fast response speed, simple circuit structure and low cost.



Figure 7. The DMD4523E is used for current limiting

In Figure 8, by selecting an appropriate Zener diode VD1, a stable output voltage Vout can be obtained. The DMD4523E can work under higher voltage, it can provide overvoltage protection and transient surge suppression for the load.



Figure 8. The DMD4523E for overcurrent and overvoltage protection



TO-252 E А b2 **C** 1 ‡ L2 D 1 c_2 D Н A1L1 Г E 1 0.25 → b1 L3 L b С е θ e1

SYMBOL	MIN	NOM	MAX
A	2.2	2.3	2.4
A1	0.00	0.05	0.10
b	0.762	0.812	0.862
b1			1.10
b2	5.23	5.33	5.43
С	0.458	1.508	0.558
c1	0.458	0.508	0.558
c2	0.80	1.00	1.20
D	6.00	6.10	6.20
D1	5.25	5.45	5.65
Н	10.00	10.10	10.20
E	6.50	6.60	6.70
E1	4.75	4.85	4.95
e1	4.37	4.57	4.77
L			1.45
L1	0.60	0.75	0.90
L2	0.90	1.10	1.30
L3	2.80	3.00	3.20
θ	0°	4°	8°
	Э	2.285	BSC



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